TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2750

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• Low drain-source ON resistance : $R_{DS (ON)} = 1.7 \Omega (typ.)$

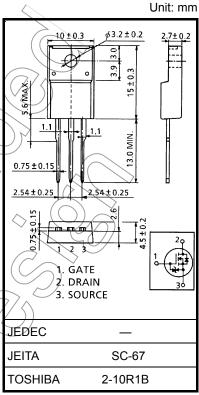
High forward transfer admittance : |Y_{fs}| = 3.0 S (typ.)

• Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 600 V)

• Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	600	(v)
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	600	V
Gate-source voltage		V_{GSS}	±30	V
Drain current	DC (Note 1)	ΙD	3.5	A
	Pulse (Note 1)	I _{DP}	14	Α
Drain power dissipatio	n (Tc = 25°C)	PD	35	W
Single pulse avalanche energy (Note 2)		EAS	201	mJ
Avalanche current		IAR)) 3.5	A
Repetitive avalanche energy (Note 3)		EAR	3.5	mJ
Channel temperature		(T _{ch})	150	∫/¢c
Storage temperature range		Tstg	-55 to 150	€,



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics Symbol	Max	Unit
Thermal resistance, channel to case Rth (ch-c)	3.57	°C / W
Thermal resistance, channel to ambient Rth (ch-a)	62.5	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 28.8 mH, R_G = 25 Ω , I_{AR} = 3.5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

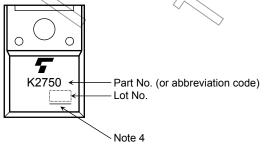
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I_{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V _(BR) GSS	$I_G = \pm 10 \mu A, V_{DS} = 0 V$	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	/	_	100	μA
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	600	_	_	V
Gate threshold v	oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) /~	4.0	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 1.8 A	\nearrow	1.7	2.2	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1.8 A	2.0	3.0	_	S
Input capacitano	e	C _{iss}		_	800	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	<i>_</i>	6	_	pF
Output capacitance		Coss		_	65		
Switching time	Rise time	t _r	V _{GS} 10V ID ID S O O O	- (15	<u> </u>	
	Turn-on time	t _{on}	$\begin{array}{c c} & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & &$		50) —	
	Fall time	t _f	v _{DD} =200V		15		ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm w} = 10 \mu {\rm s}$	<u> </u>	85	1	
Total gate charg plus gate-drain)		Qg			20	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, V_{D} = 3.5 \text{ A}$	_	10	_	nC
Gate-drain ("miller") Charge		Q _{gd}		_	10	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current	1 _{DR}	<u> </u>	_	_	3	Α
Pulse drain reverse current (Note 1)) I _{DRP}	_	_	_	14	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 3.5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 3.5 A, V _{GS} = 0 V	1	1400	1	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	_	9	_	μC

Marking



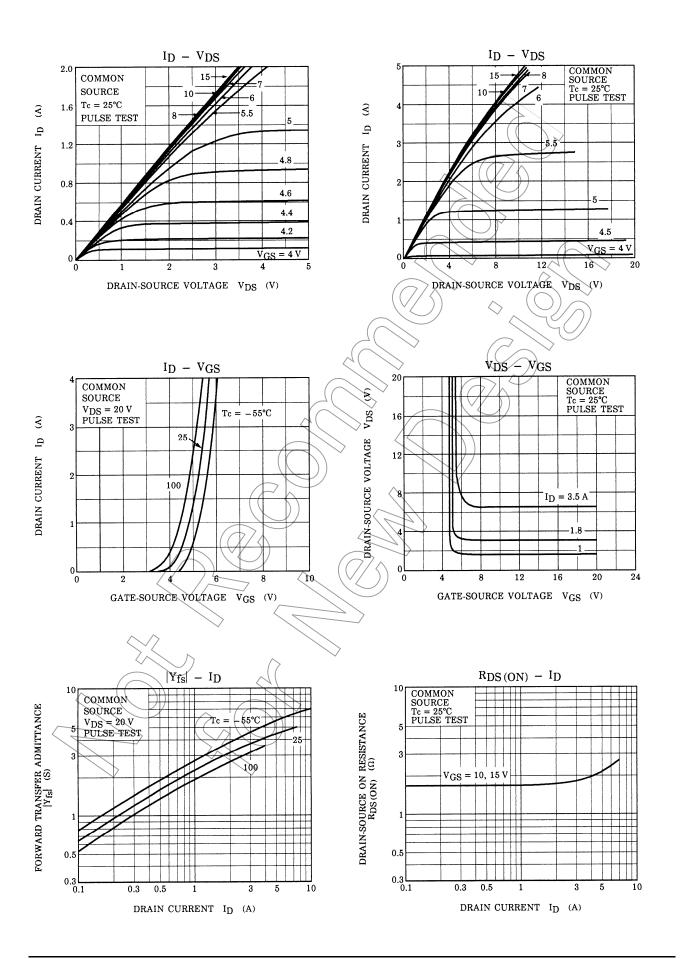
Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

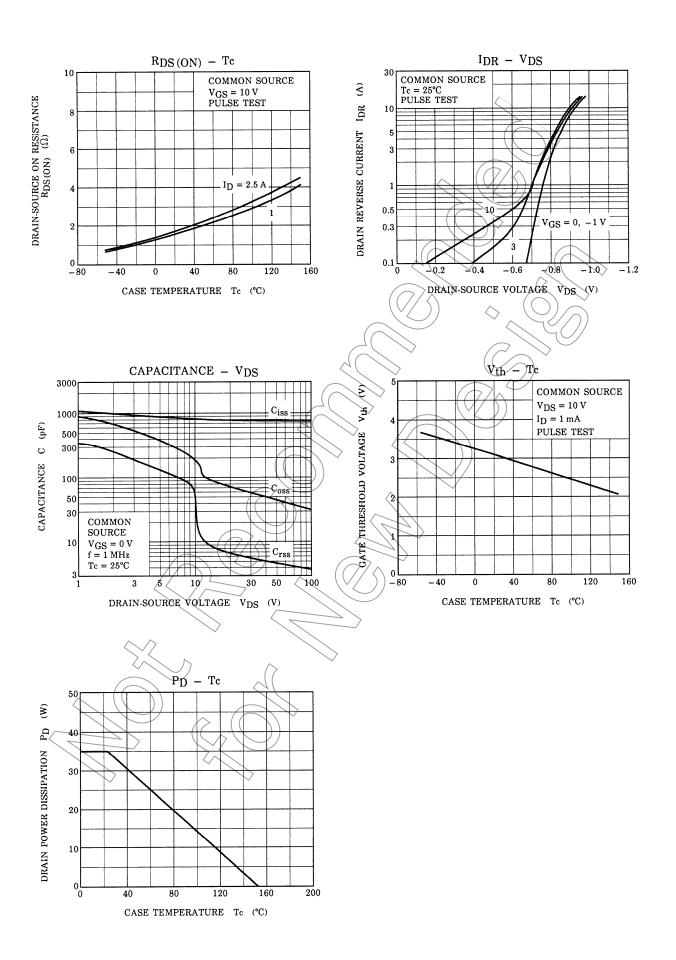
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

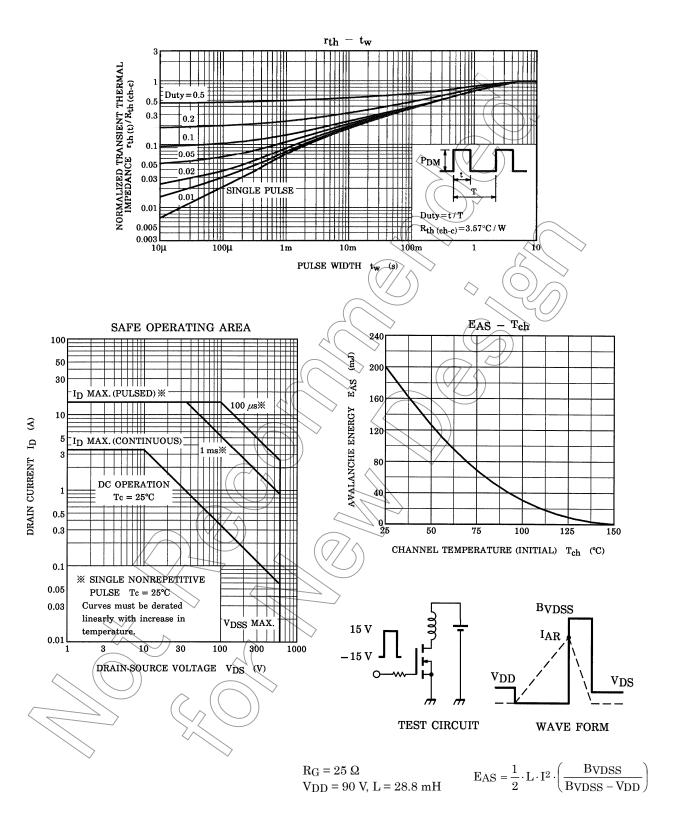
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